



## UTM6016

Power MOSFET

### 12A, 60V N-CHANNEL FAST SWITCHING MOSFET

#### DESCRIPTION

The UTC **UTM6016** is an N-Channel MOSFET, it uses UTC's advanced technology to provide customers with a minimum on-state resistance, high switching speed and low gate charge.

The UTC **UTM6016** is suitable for application in networking DC-DC power system and LCD/LED back light, etc.

#### FEATURES

##### TO-220/TO-252/SOP-8/PDFN5x6

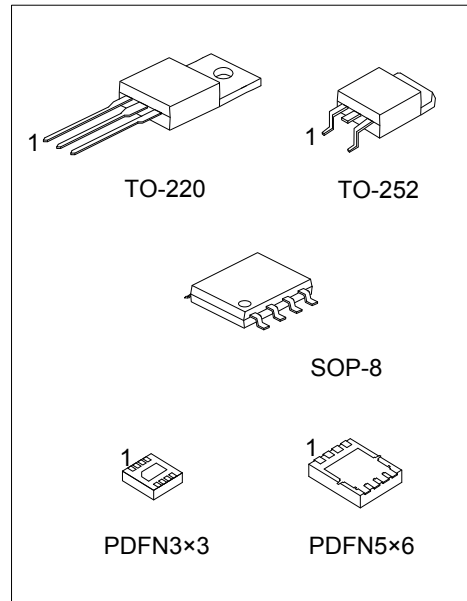
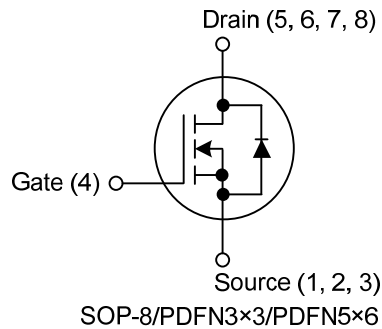
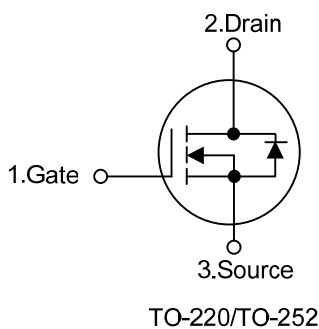
- \*  $R_{DS(ON)} \leq 12 \text{ m}\Omega @ V_{GS}=10\text{V}, I_D=8.0\text{A}$
- $R_{DS(ON)} \leq 15 \text{ m}\Omega @ V_{GS}=4.5\text{V}, I_D=6.0\text{A}$

##### PDFN3x3

- \*  $R_{DS(ON)} \leq 13 \text{ m}\Omega @ V_{GS}=10\text{V}, I_D=8.0\text{A}$
- $R_{DS(ON)} \leq 16 \text{ m}\Omega @ V_{GS}=4.5\text{V}, I_D=6.0\text{A}$

- \* Low gate charge
- \* Excellent  $CdV/dt$  effect decline
- \* High switching speed

#### SYMBOL



### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UTM6016L-TA3-T	UTM6016G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
UTM6016L-TN3-R	UTM6016G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UTM6016L-S08-R	UTM6016G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel
UTM6016L-P3030-R	UTM6016G-P3030-R	PDFN3×3	S	S	S	G	D	D	D	D	Tape Reel
UTM6016L-P5060-R	UTM6016G-P5060-R	PDFN5×6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>UTM6016G-TA3-T</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TN3: TO-252, S08: SOP-8, P5060: PDFN5×6 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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### MARKING

TO-252	SOP-8
<p>UTC UTM6016 Lot Code Date Code</p>	<p>UTC UTM6016 Lot Code Date Code</p>
PDFN3×3	PDFN5×6
<p>UTM 6016 Date Code</p>	<p>UTC UTM 6016 Lot Code Date Code</p>

■ ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	60	V
Gate-Source Voltage		$V_{GSS}$	$\pm 20$	V
Drain Current	Continuous	$I_D$	12	A
	Pulsed (Note 2)	$I_{DM}$	32	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	66	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.6	V/ns
Power Dissipation (Note 4)	TO-220	$P_D$	140	W
	TO-252		52	W
	SOP-8		5	W
	PDFN3x3		20	W
	PDFN5x6		28	W
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L=0.1\text{mH}$ ,  $I_{AS}=25\text{A}$ ,  $V_{DD}=25\text{V}$ ,  $R_G=25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD}\leq 12\text{A}$ ,  $di/dt\leq 200\text{A}/\mu\text{s}$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

5. The power dissipation is limited by  $150^\circ\text{C}$  junction temperature.

■ THERMAL DATA (Note 1)

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
	TO-252		110	
	SOP-8		125	
	PDFN3x3		130	
	PDFN5x6		62	
Junction to Case	TO-220	$\theta_{JC}$	0.89	$^\circ\text{C}/\text{W}$
	TO-252		2.4	
	SOP-8		25	
	PDFN3x3		6.25	
	PDFN5x6		4.46	

Notes: 1. The data tested by surface mounted on a  $1\text{ inch}^2$  FR-4 board with 2OZ copper.

2. The data tested by pulsed, pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .

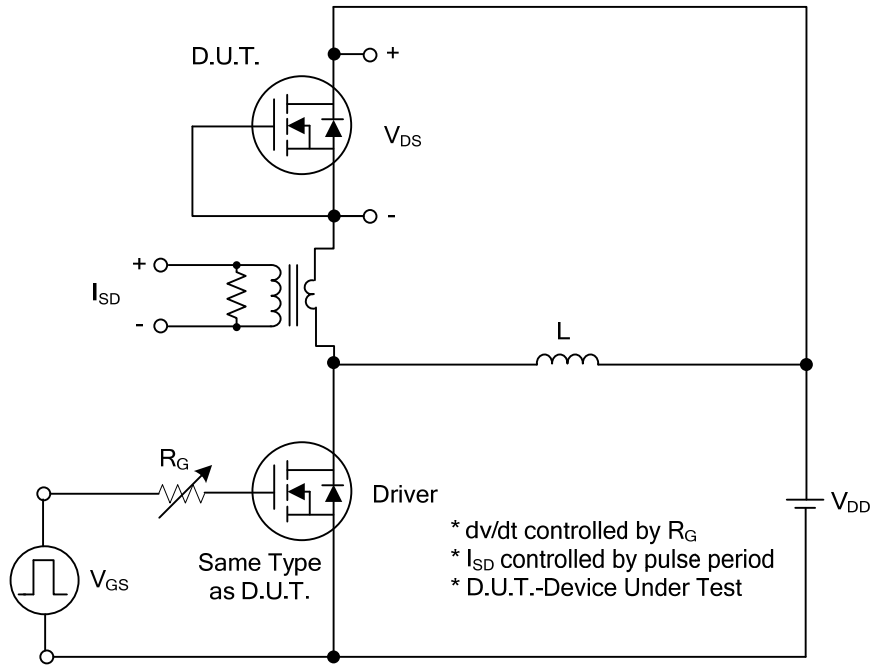
■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise noted)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	60			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =48V, V <sub>GS</sub> =0V			1	μA
Gate-Source Leakage Current	Forward	I <sub>GSS</sub>	V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			+100	nA
	Reverse		V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-100	nA
<b>ON CHARACTERISTICS</b>							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0		2.5	V
Static Drain-Source On-State Resistance	TO-220	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =8.0A			12	mΩ
	TO-252		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6.0A			15	mΩ
	SOP-8		V <sub>GS</sub> =10V, I <sub>D</sub> =8.0A			13	mΩ
	PDFN5×6		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6.0A			16	mΩ
	PDFN3×3						
<b>DYNAMIC PARAMETERS</b>							
Input Capacitance		C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		2000		pF
Output Capacitance		C <sub>OSS</sub>			209		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			170		pF
<b>SWITCHING PARAMETERS</b>							
Total Gate Charge (Note 1)		Q <sub>G</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =12A I <sub>G</sub> =1mA		57		nC
Gate to Source Charge		Q <sub>GS</sub>			6		nC
Gate to Drain Charge		Q <sub>GD</sub>			14		nC
Turn-ON Delay Time (Note 1)		t <sub>D(ON)</sub>	V <sub>DD</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =12A, R <sub>G</sub> =3.3Ω (Note 1, 2)		8		ns
Rise Time		t <sub>R</sub>			17		ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>			44		ns
Fall-Time		t <sub>F</sub>			21		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>							
Maximum Body-Diode Continuous Current		I <sub>S</sub>				12	A
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				32	A
Drain-Source Diode Forward Voltage (Note 1)		V <sub>SD</sub>	I <sub>S</sub> =12A, V <sub>GS</sub> =0V			1.2	V
Body Diode Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =12A, V <sub>GS</sub> =0V,		35		nS
Body Diode Reverse Recovery Charge		Q <sub>rr</sub>	dI <sub>F</sub> /dt=100A/μs		25		nC

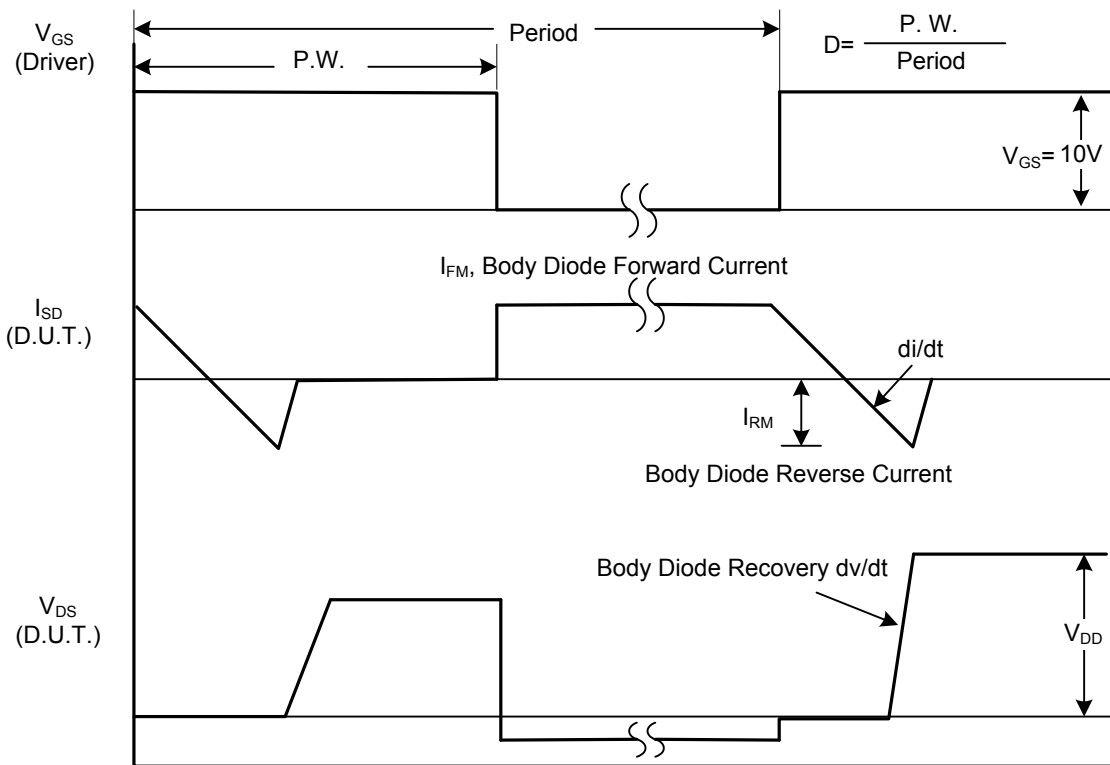
Notes: 1. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

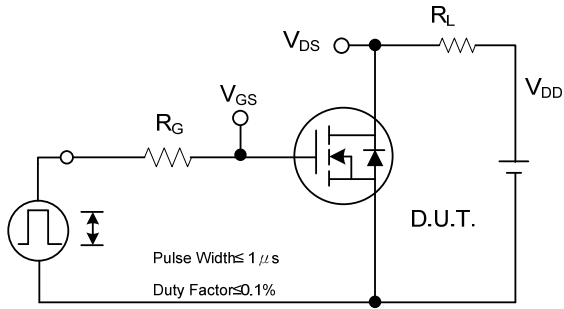


Peak Diode Recovery dv/dt Test Circuit

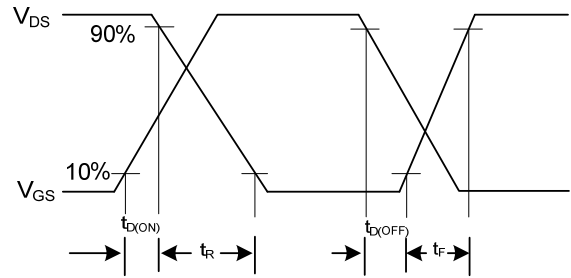


Peak Diode Recovery dv/dt Waveforms

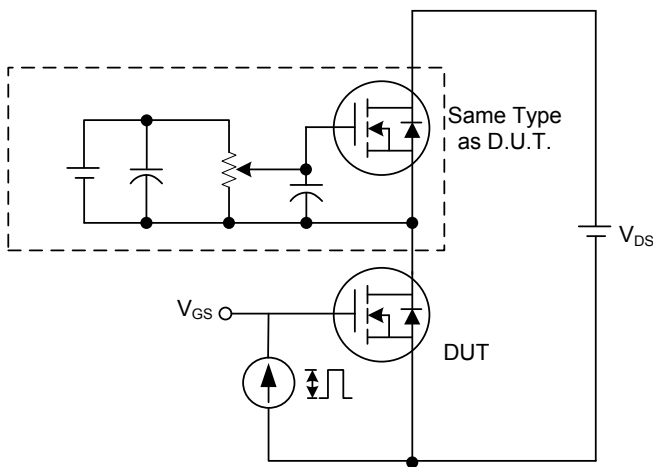
■ TEST CIRCUITS AND WAVEFORMS



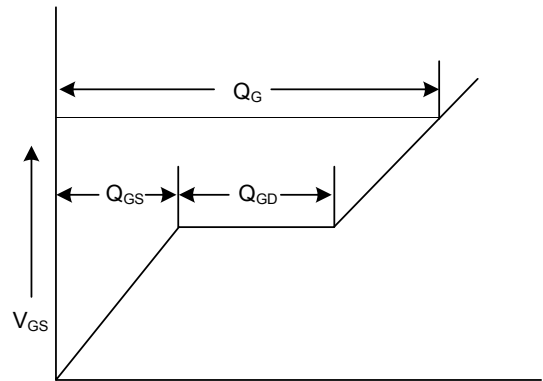
Switching Test Circuit



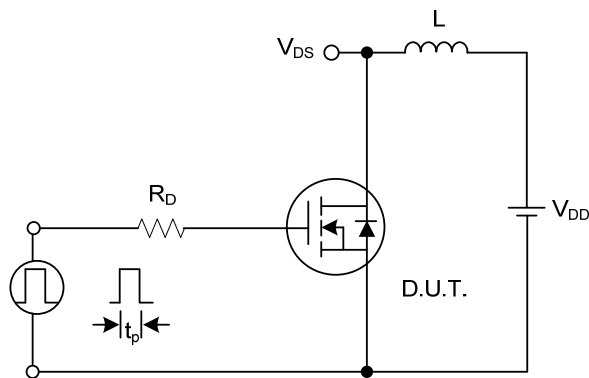
Switching Waveforms



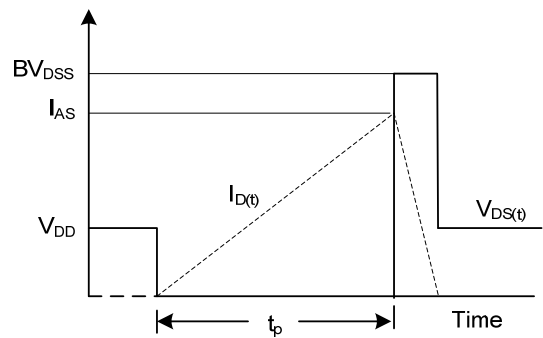
Gate Charge Test Circuit



Gate Charge Waveform

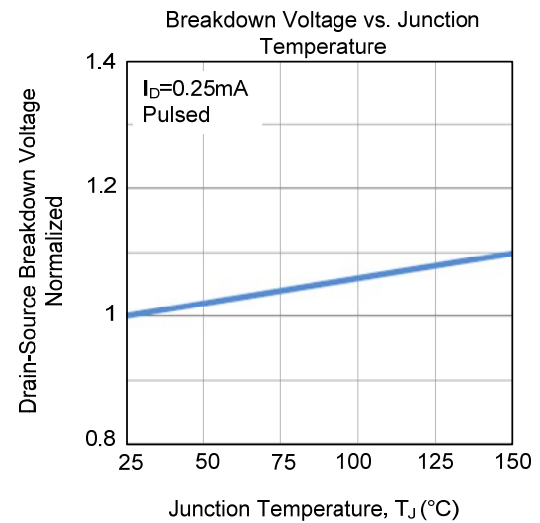
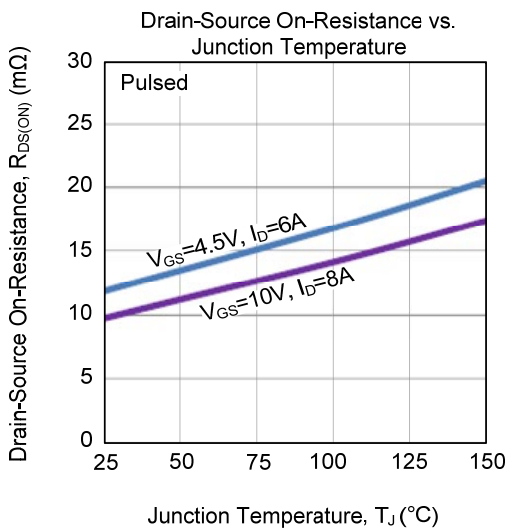
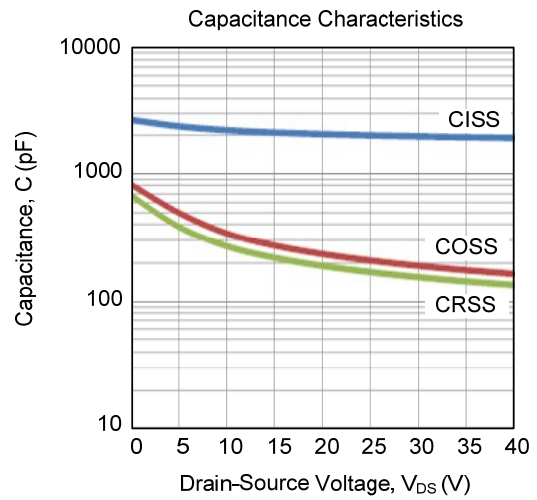
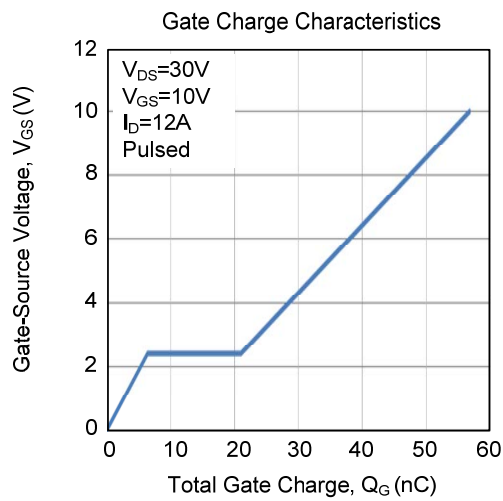
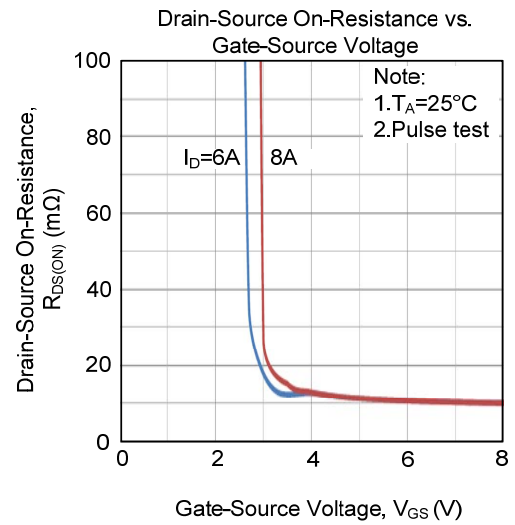
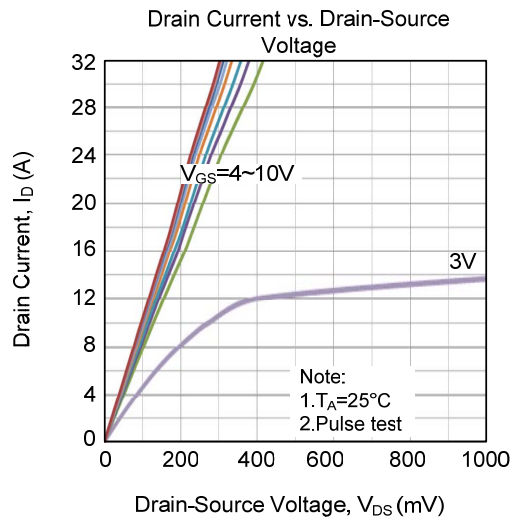


Unclamped Inductive Switching Test Circuit

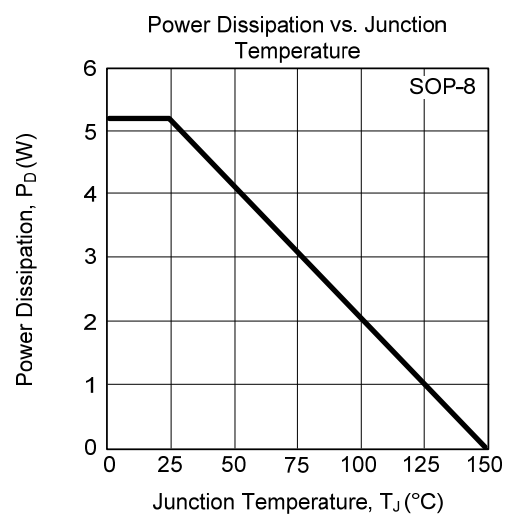
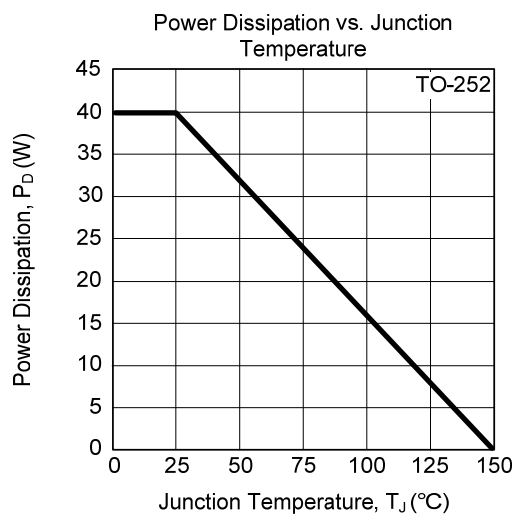
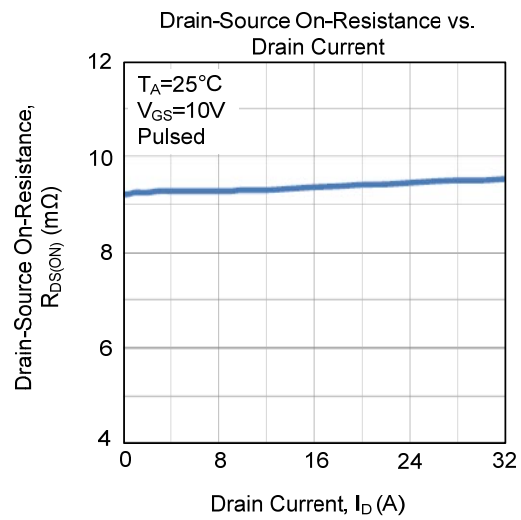
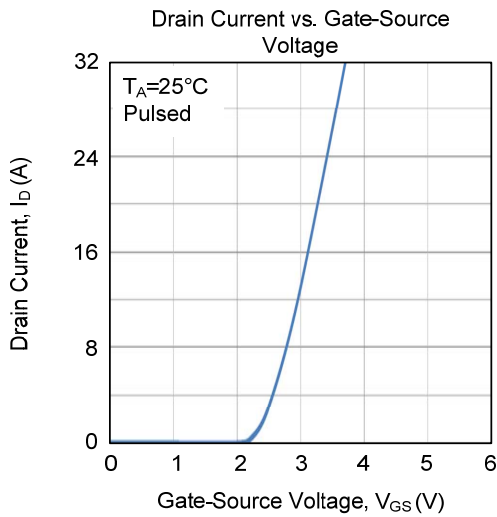
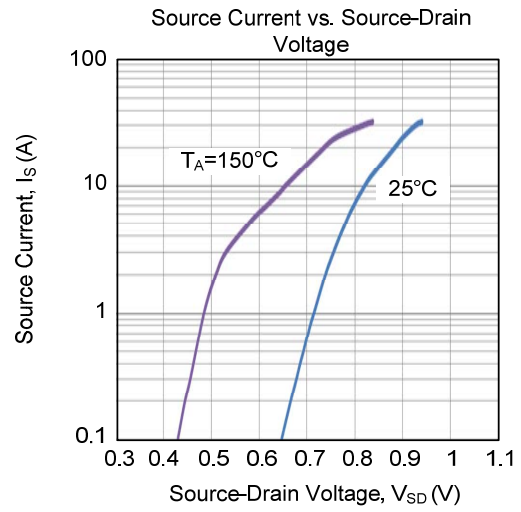
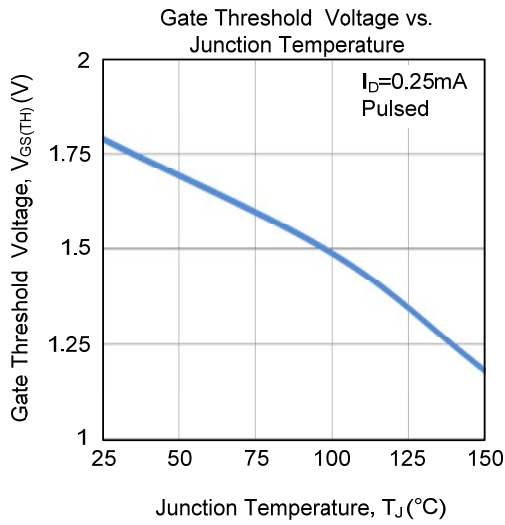


Unclamped Inductive Switching Waveforms

## TYPICAL CHARACTERISTICS

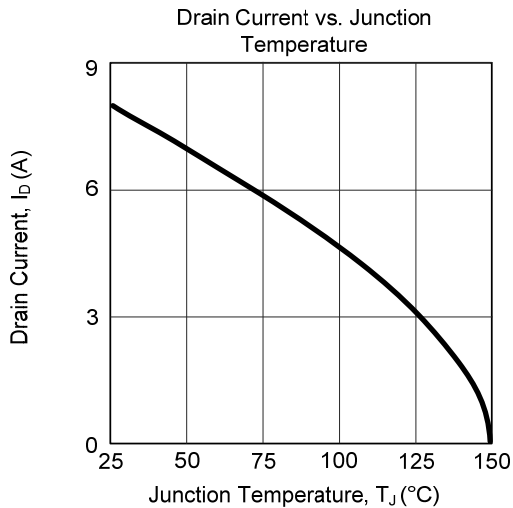
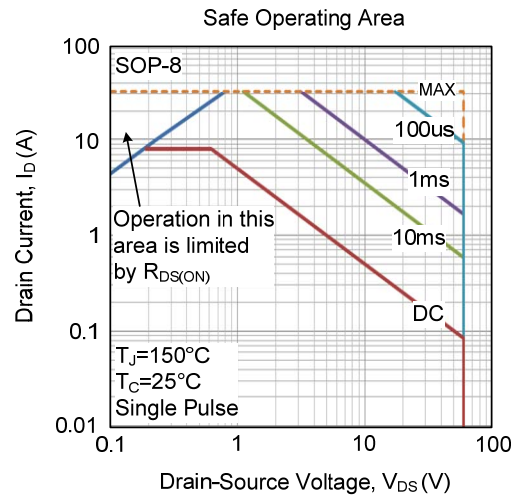
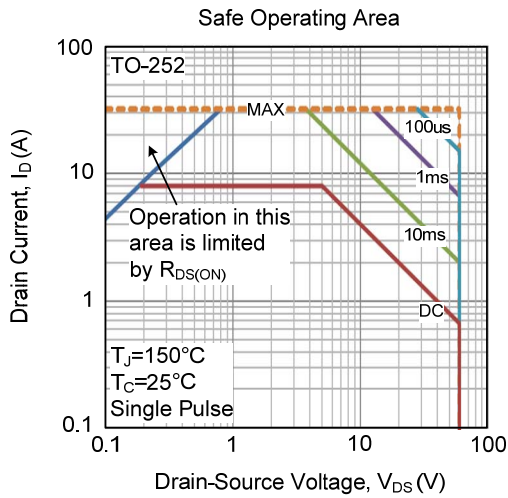


## TYPICAL CHARACTERISTICS (Cont.)





## ■ TYPICAL CHARACTERISTICS (Cont.)



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